

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

First

Named

Inventor: Tinghao F. Wang

Serial No.: 10/071,809

Examiner: Duy Vu Nguyen Deo

Filing

Date: February 7, 2002

Group Art Unit No. 1765

Title: METHOD FOR SELECTIVELY  
ETCHING SILICON AND/OR  
METAL SILICIDES

**TRANSMITTAL**

The following correspondence is being sent electronically to:

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450


on

July 24, 2006

Date

Paul E. Rauch, Ph.D., Registration No. 38,591

typed or printed name of person signing Certificate



1. Reply Brief.

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